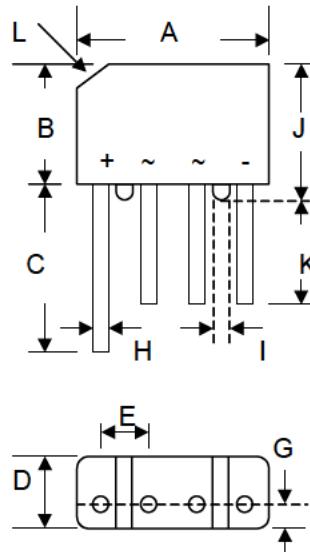


Features

- Diffused Junction
- Low Forward Voltage Drop
- High Current Capability
- High Reliability
- High Surge Current Capability
- Ideal for Printed Circuit Boards
- UL Recognized File # E157705

KBP200-KBP210



KBP		
Dim	Min	Max
A	14.22	15.24
B	10.67	11.68
C	15.2	—
D	4.57	5.08
E	3.60	4.10
G	2.16	2.67
H	0.76	0.86
I	1.52	—
J	11.68	12.7
K	12.7	—
L	3.2 x 45° Typical	
All Dimensions in mm		

Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Body
- Weight: 1.7 grams (approx.)
- Mounting Position: Any
- Marking: Type Number

Maximum Ratings and Electrical Characteristics $\text{@T}_A=25^\circ\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	KBP 200	KBP 201	KBP 202	KBP 204	KBP 206	KBP 208	KBP 210	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Rectified Output Current (Note 1) $\text{@T}_A = 50^\circ\text{C}$	I _o				2.0				A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}				60				A
Forward Voltage (per element) $\text{@I}_F = 2.0\text{A}$	V _{FM}				1.1				V
Peak Reverse Current $\text{@T}_A = 25^\circ\text{C}$ At Rated DC Blocking Voltage $\text{@T}_A = 100^\circ\text{C}$	I _{RM}				10	500			μA
Rating for Fusing ($t < 8.3\text{ms}$)	I ² t				15				A^2s
Typical Junction Capacitance per element (Note 2)	C _j				25				pF
Typical Thermal Resistance (Note 3)	R _{θJA}				30				K/W
Operating and Storage Temperature Range	T _j , T _{TSG}				-55 to +165				°C

Note: 1. Leads maintained at ambient temperature at a distance of 9.5mm from the case.

2. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

3. Thermal resistance junction to ambient mounted on PC board with 12mm² copper pad.

KBP200-KBP210

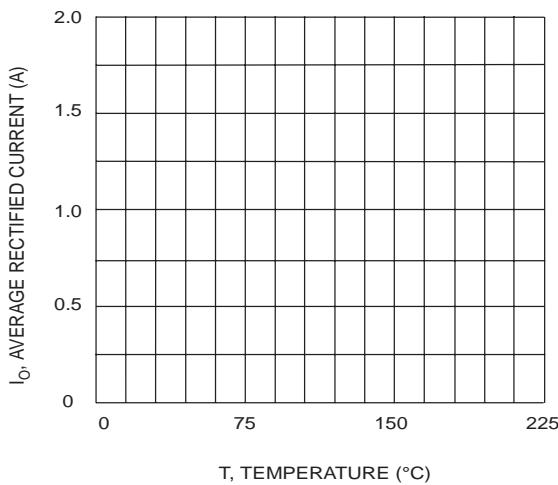


Fig. 1 Forward Current Derating Curve

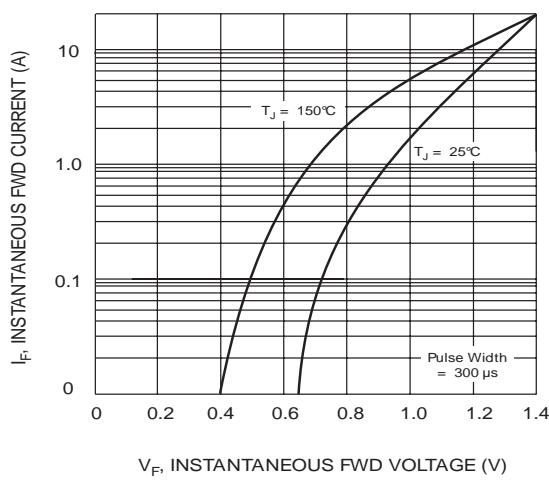


Fig. 2 Typical Fwd Characteristics

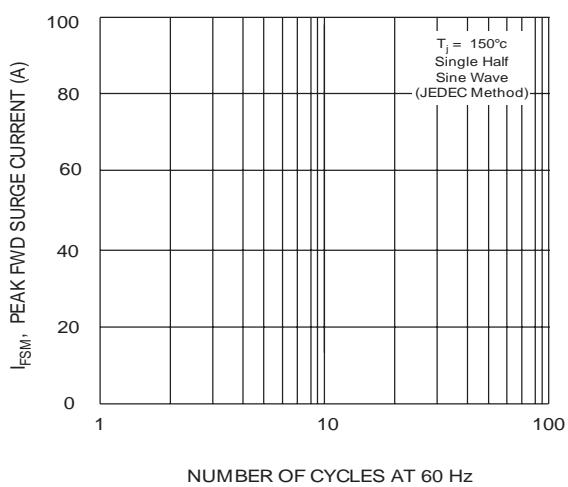


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

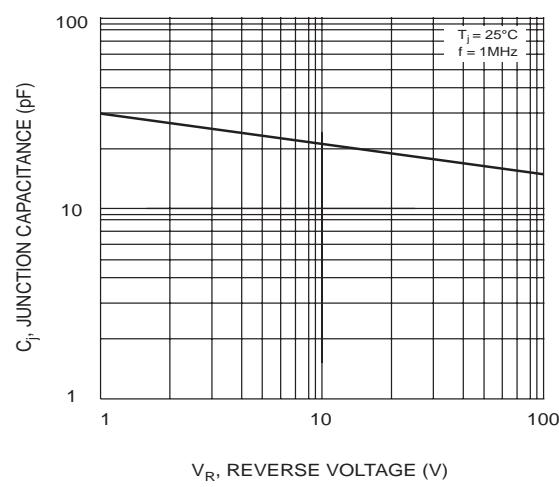


Fig. 4 Typical Junction Capacitance

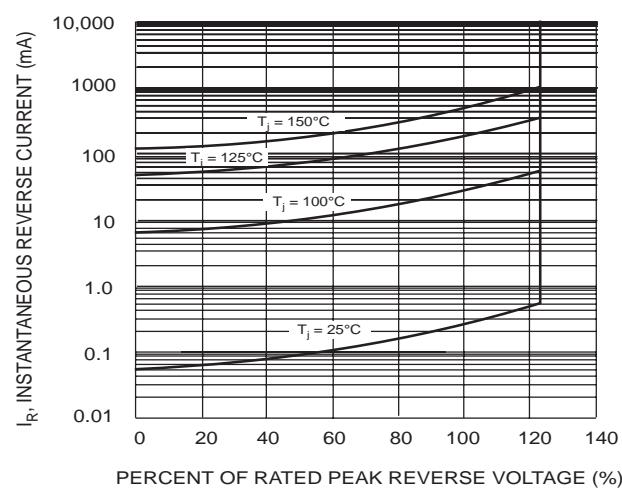


Fig. 5 Typical Reverse Characteristics